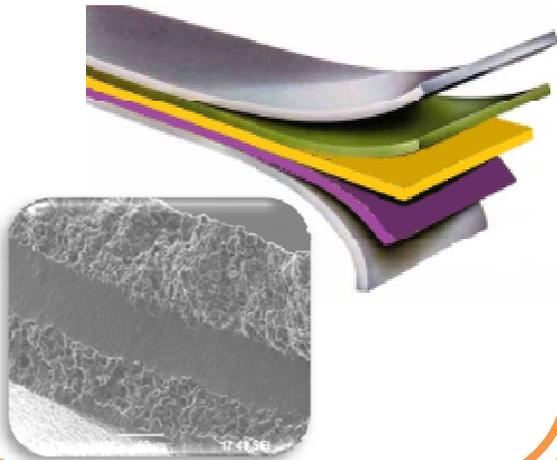


ENERGY HARVESTING FROM VIBRATIONS, AIR FLOW, & TEMPERATURE CHANGE

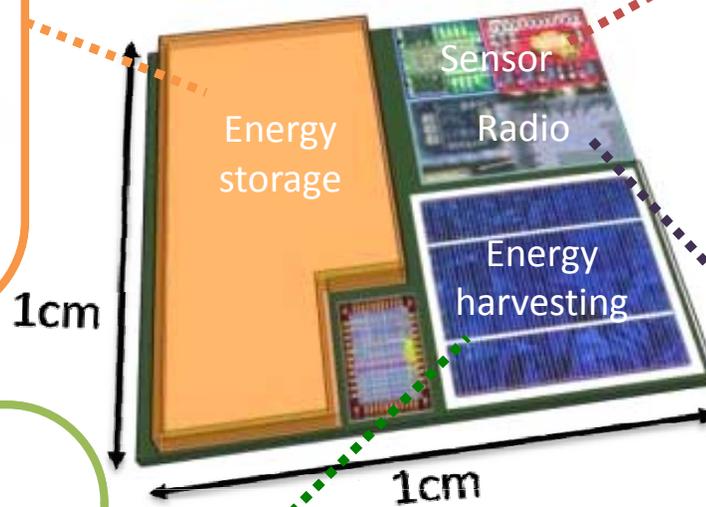
Lindsay Miller, Alic Chen, Deepa Madan
Lee Weinstein, Peter So, Thomas Devloo,
Dr. Elizabeth Reilly, Dr. Yiping Zhu,
Prof. Paul Wright, Prof. Jim Evans

System on a Chip

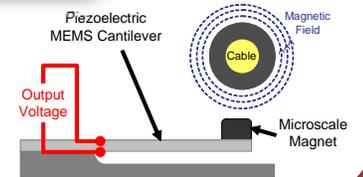
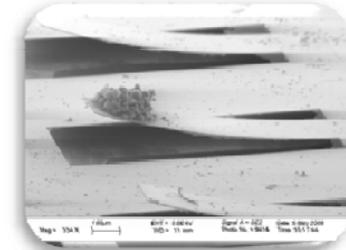
Energy Storage



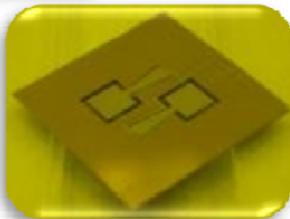
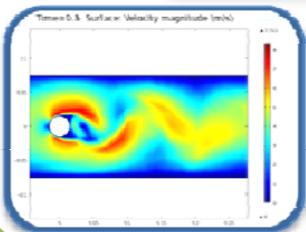
Wireless Sensor Micro-device



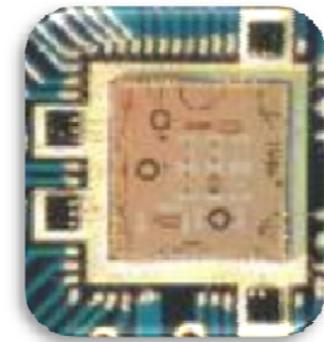
MEMS Sensor



Energy Harvesting



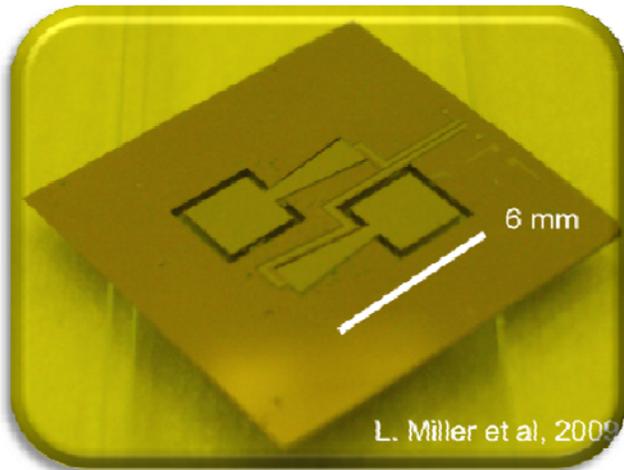
Radio



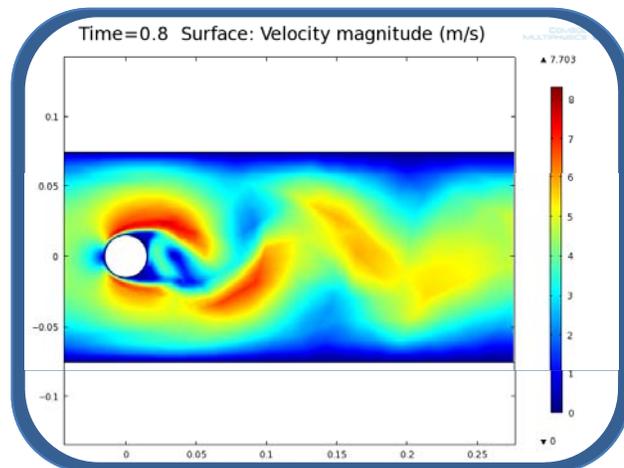
Multi-source energy harvesting

PIEZOELECTRIC

VIBRATIONS

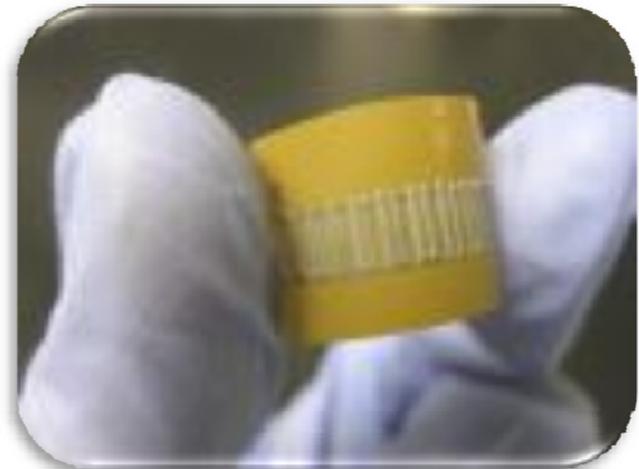


AIR FLOW



THERMOELECTRIC

TEMPERATURE DIFFERENCE



Progress made in past 6 months:

PIEZOELECTRIC

VIBRATIONS

- $P_{\text{rms}} = 1.1 \text{ nW/beam}$,
micro device on ambient source
- Developed process to modify
frequency with printed mass

AIR FLOW

- Meso-scale prototype developed
- $P_{\text{rms}} = 1.1 \text{ mW}$, optimal conditions

THERMOELECTRIC

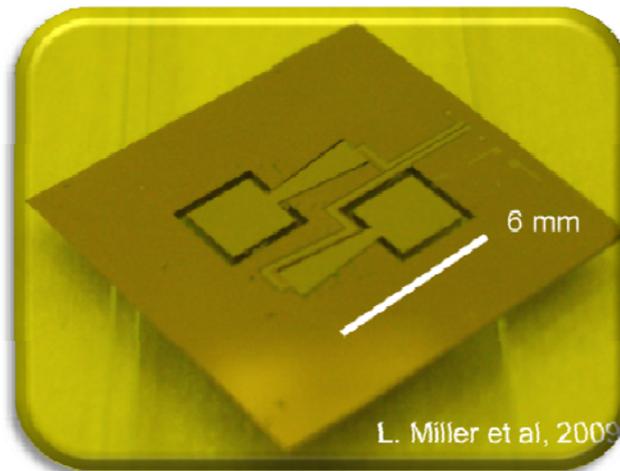
TEMPERATURE DIFFERENCE

- Composite materials improved
- Developed scalable fabrication
process for meso-scale devices
- $P = 0.58 \text{ } \mu\text{W}$
($\Delta T = 10 \text{ K}$, 10-couple device)

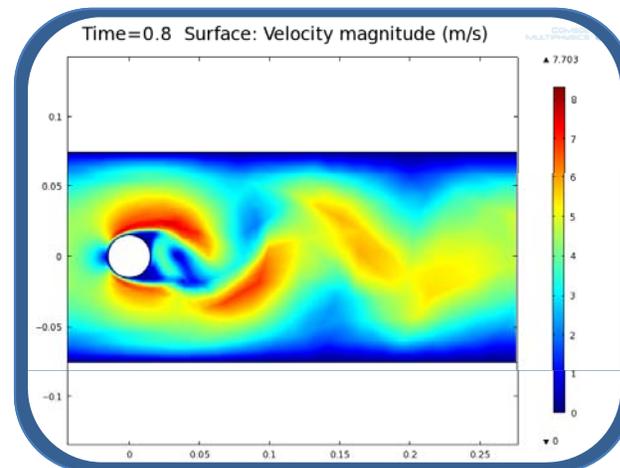
Multi-source energy harvesting

PIEZOELECTRIC

VIBRATIONS



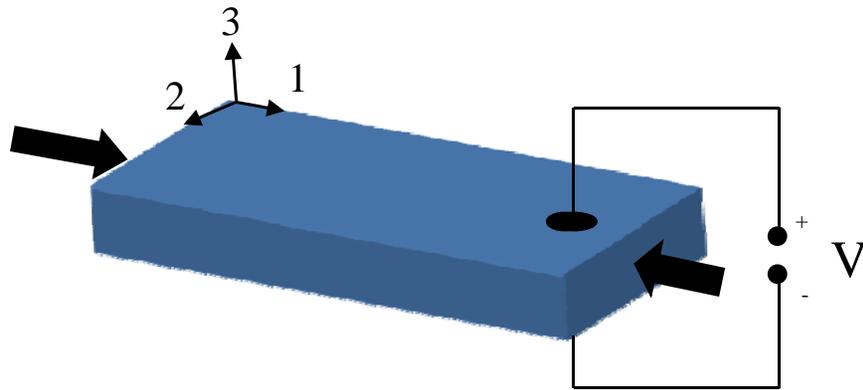
AIR FLOW



Piezoelectric operating principle



PIEZOELECTRIC MATERIAL



S. Roundy, PhD Thesis UC Berkeley 2003

CANTILEVER BEAM

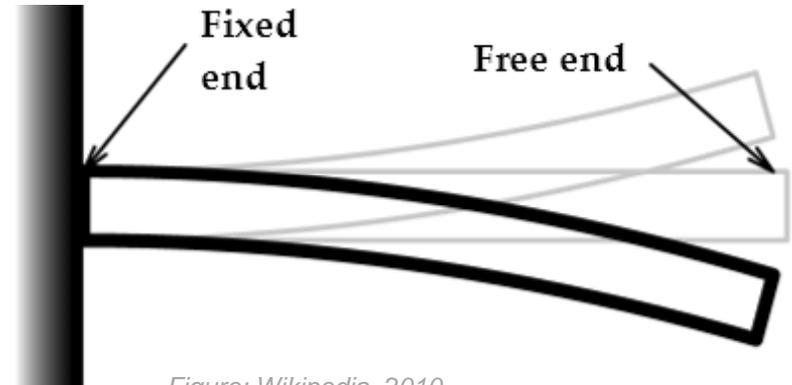


Figure: Wikipedia, 2010



Where we left you 6 months ago:

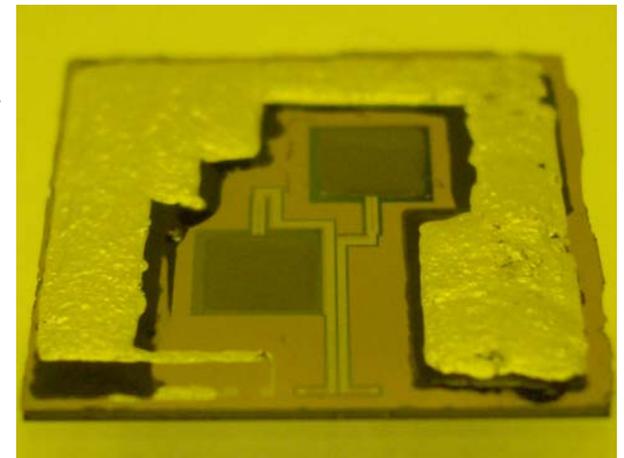
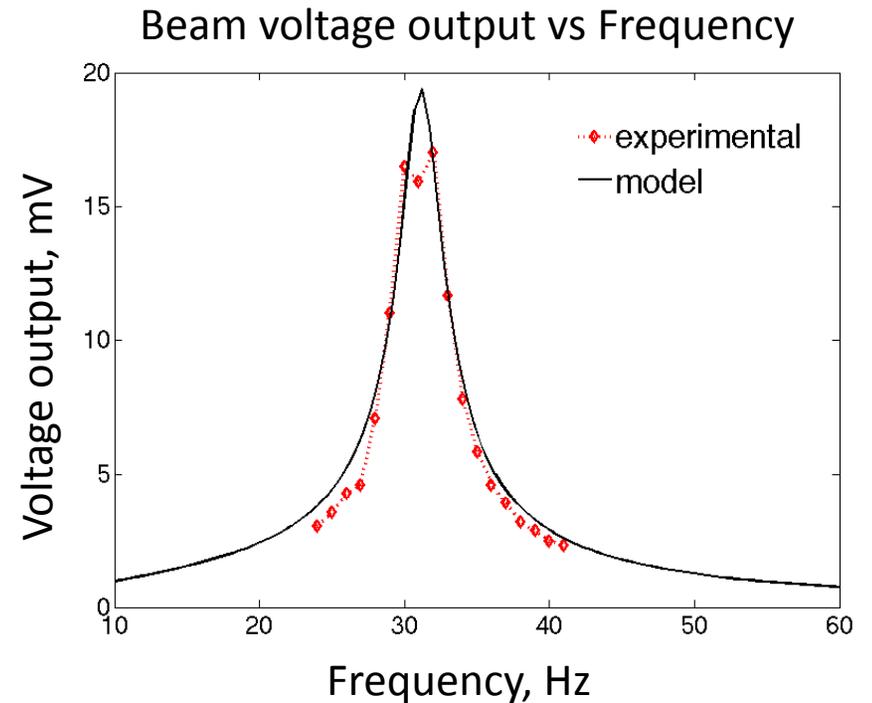
PIEZOELECTRIC

VIBRATIONS

- MEMS harvester fabricated
- Low resonance frequency achieved
- $P_{\text{rms}} = 1 \text{ nW}$ on shaker table
- 1 beam tested on 1 ambient source
- Printed capacitor on harvester die

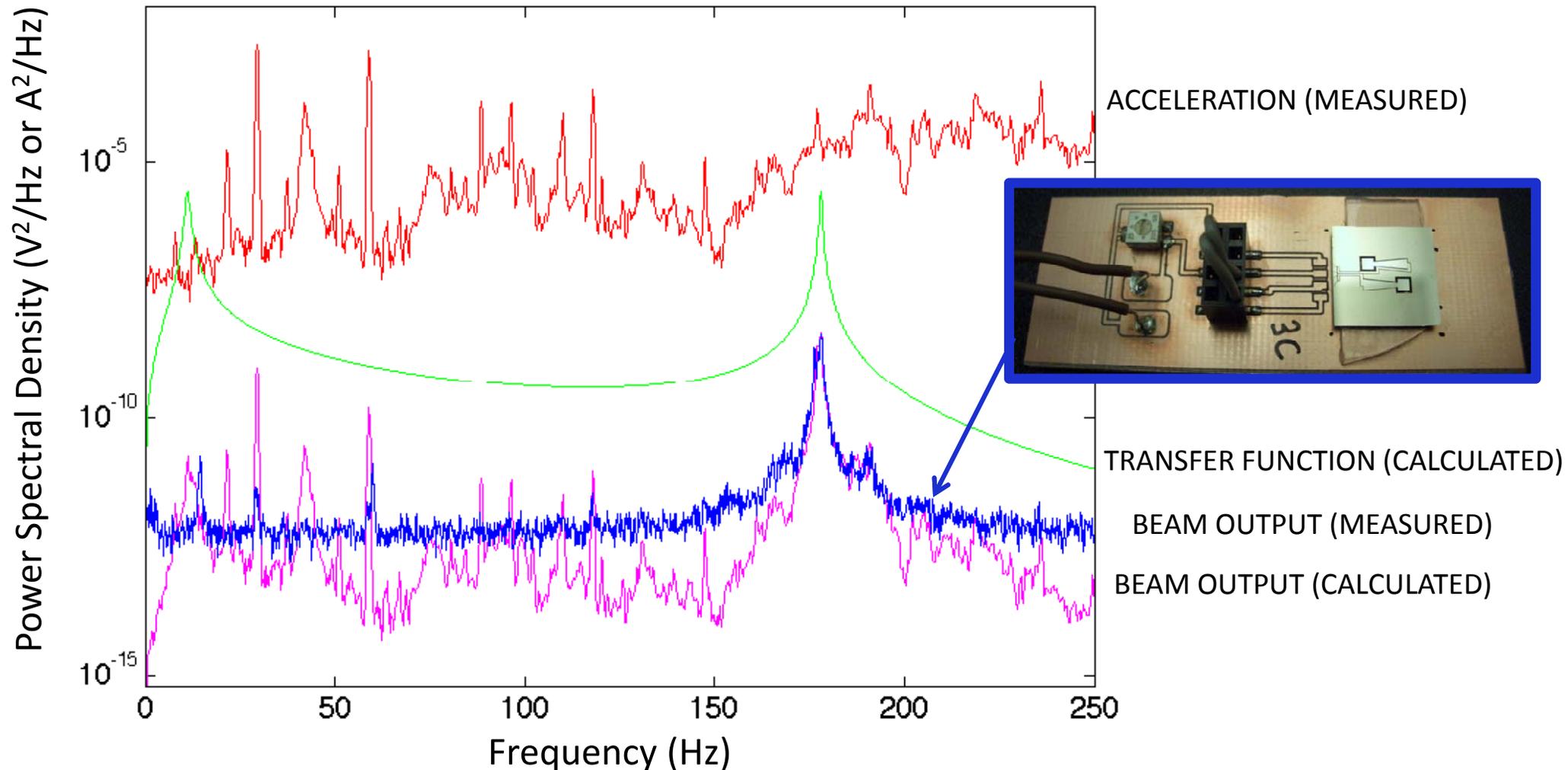
AIR FLOW

- Project was just starting



Progress: ambient vibration harvesting

Ambient vibration source: compressor

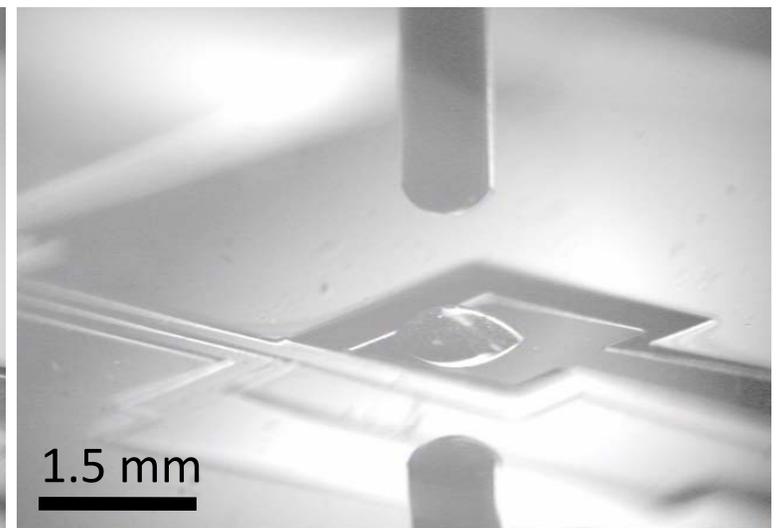
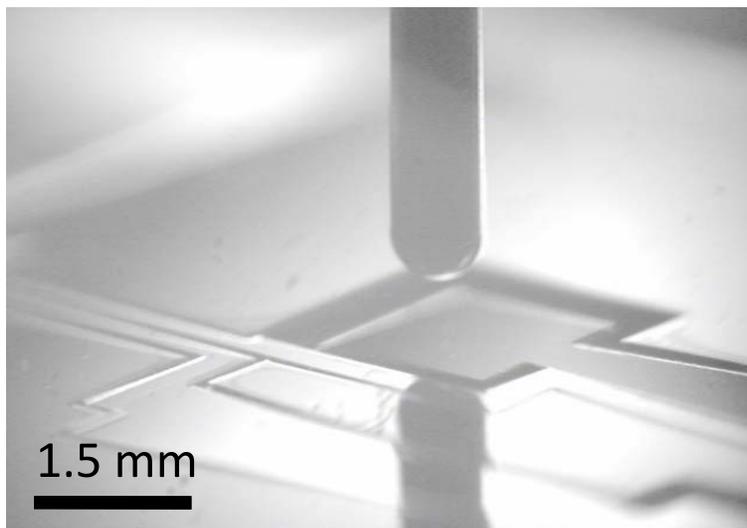
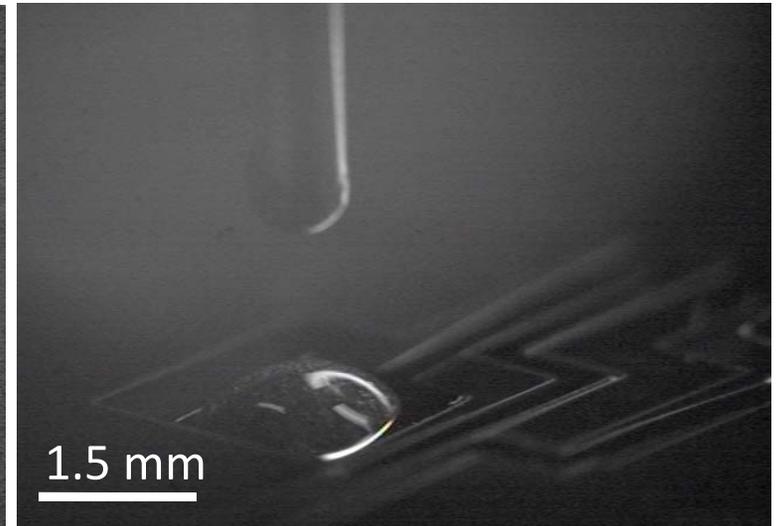
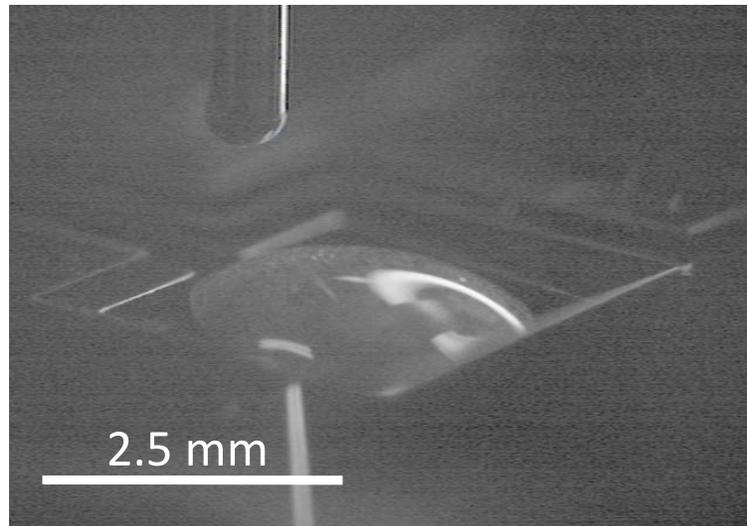
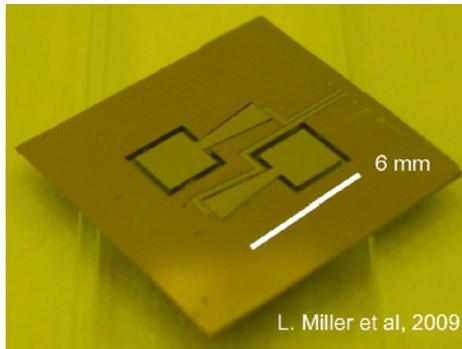


- Tested 9 beams on 7 ambient sources – reliably produce low power
- Almost finished with model – measured accel. input → predicted beam output

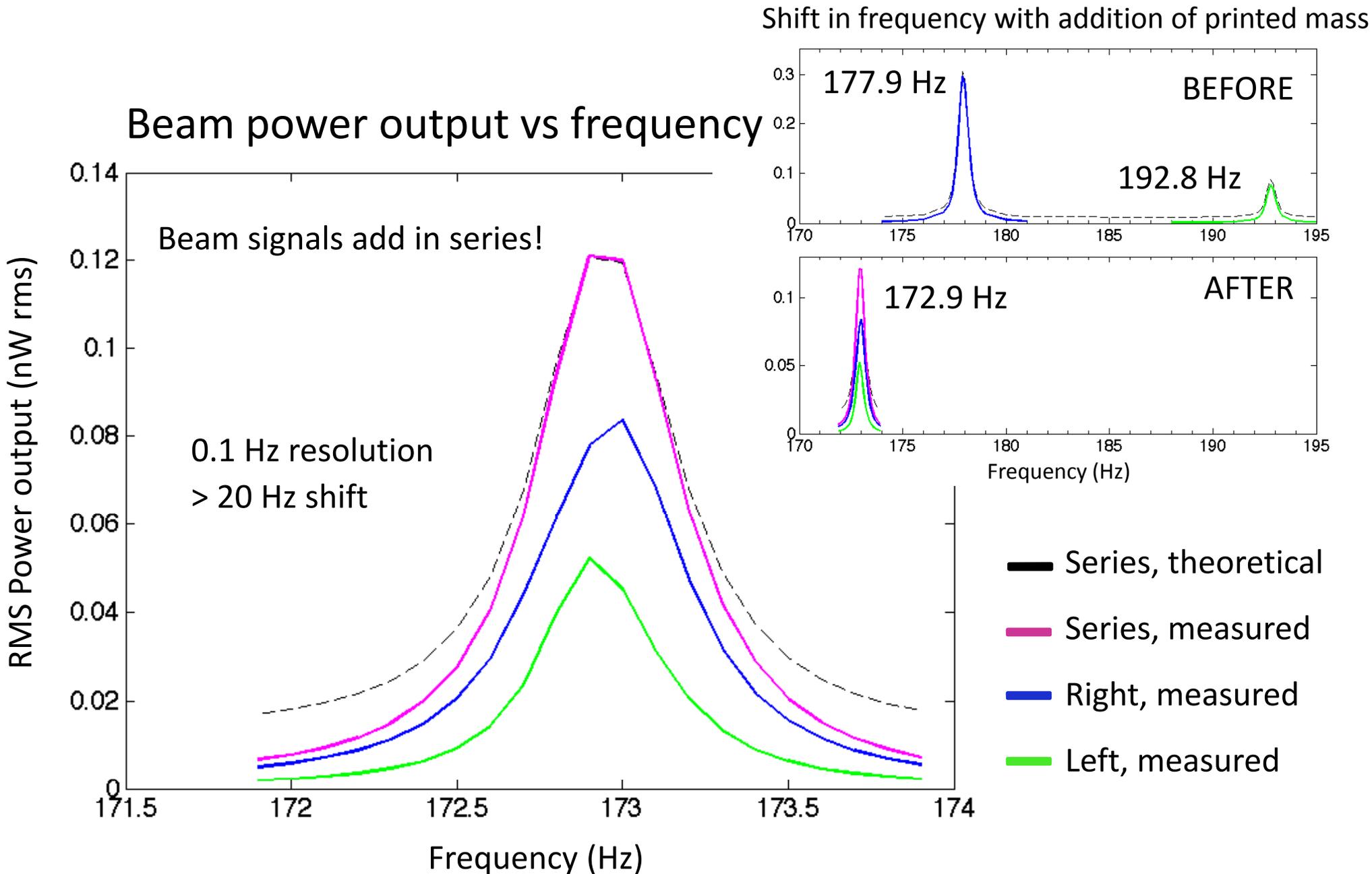
Progress: print mass \rightarrow modify frequency

Successfully printed on 6 released beams with no “casualties”

$$\omega^2 = k/m$$

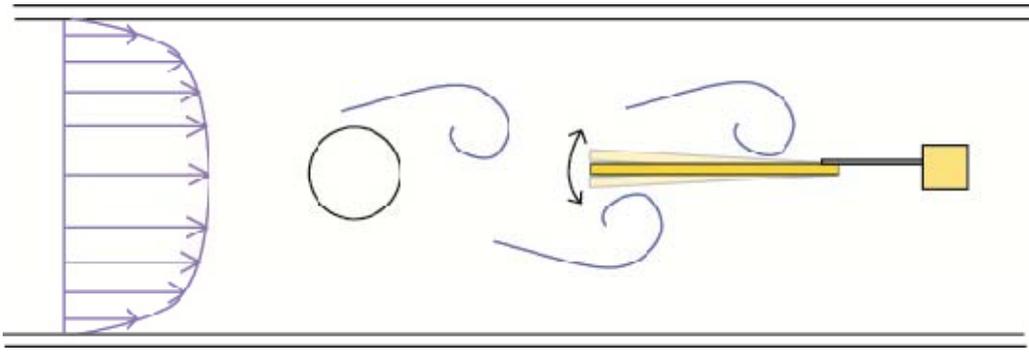


Progress: print mass \rightarrow modify frequency

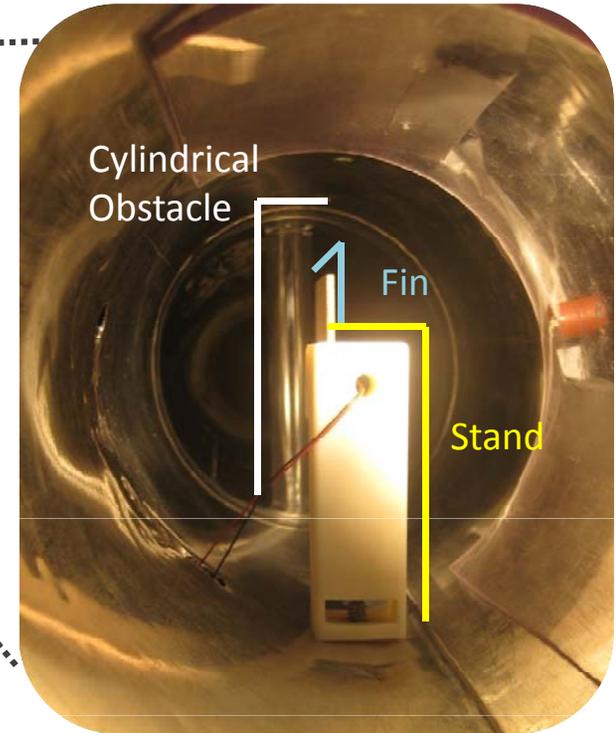


Progress: air flow harvester design

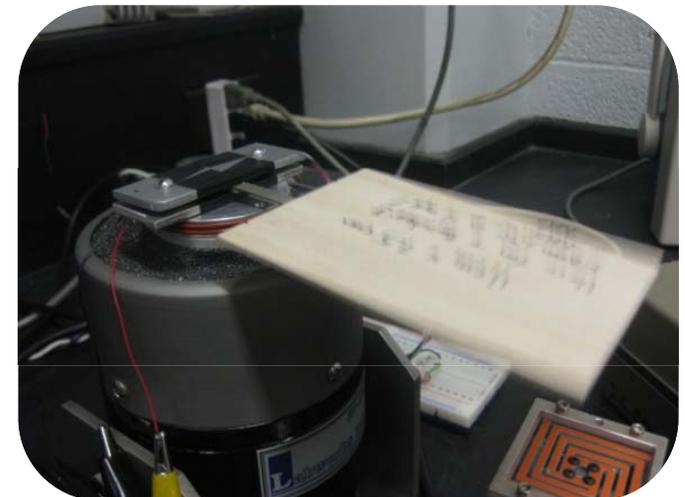
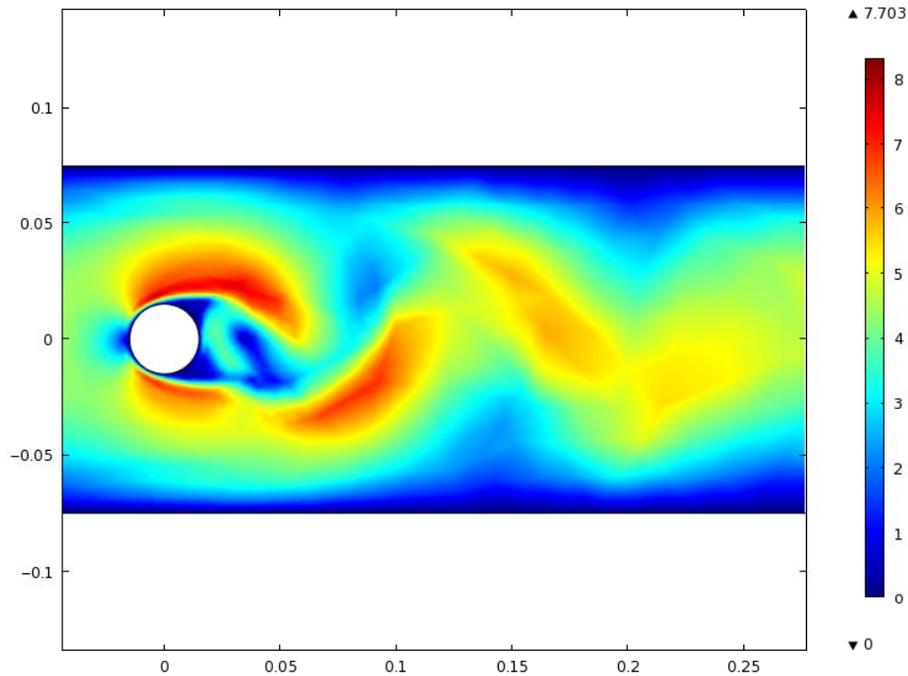
Top View



Back View

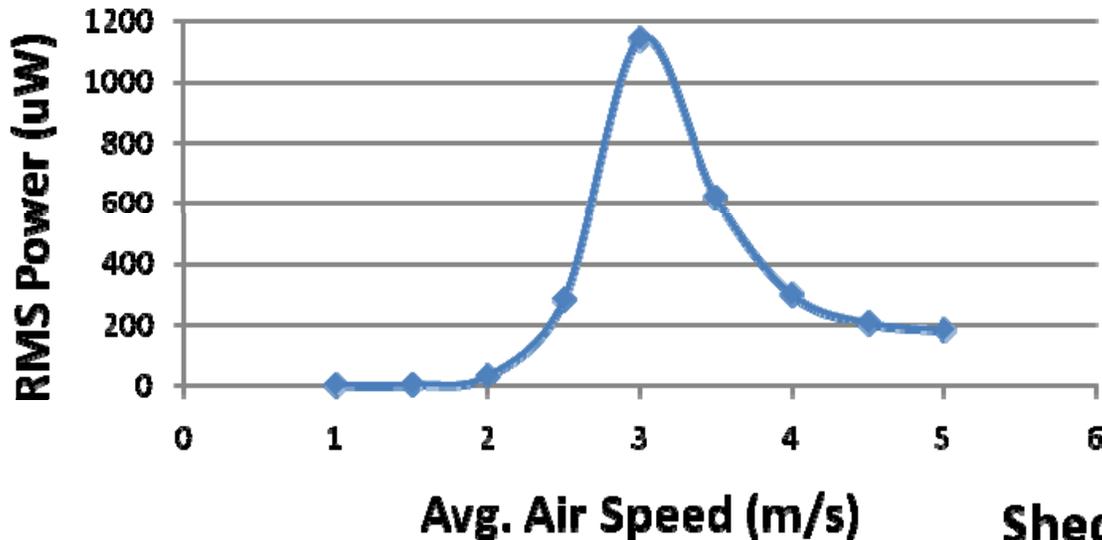


Time=0.8 Surface: Velocity magnitude (m/s)



Progress: air flow harvester performance

Power vs. Air Speed



Power output > 1 mW
at optimal conditions

For results shown:

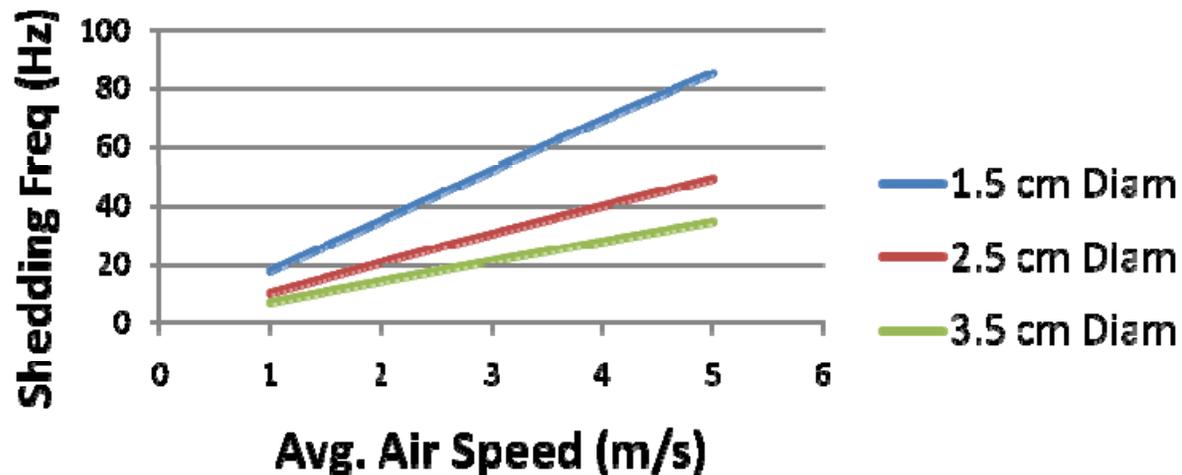
Fin: 7.5 cm wide x 7 cm long

Fin material: balsa wood

Cylinder Diameter: 2.5 cm

Optimum Load R: 194 kOhm

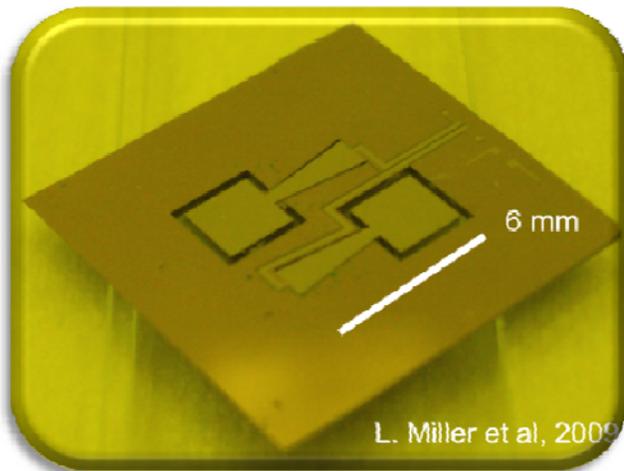
Shedding Frequency vs. Air Speed for Various Cylinder Diameters



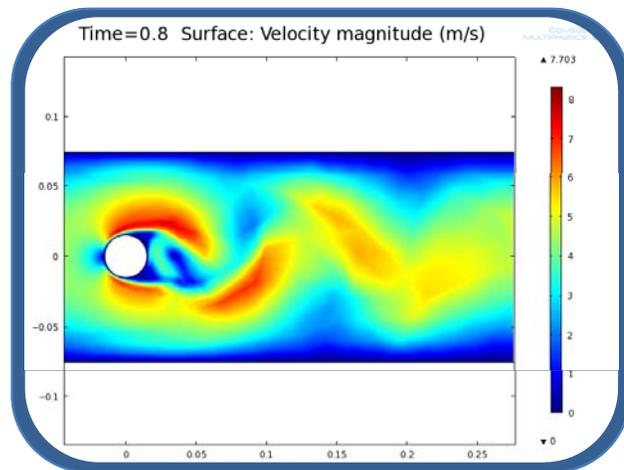
Multi-source energy harvesting

PIEZOELECTRIC

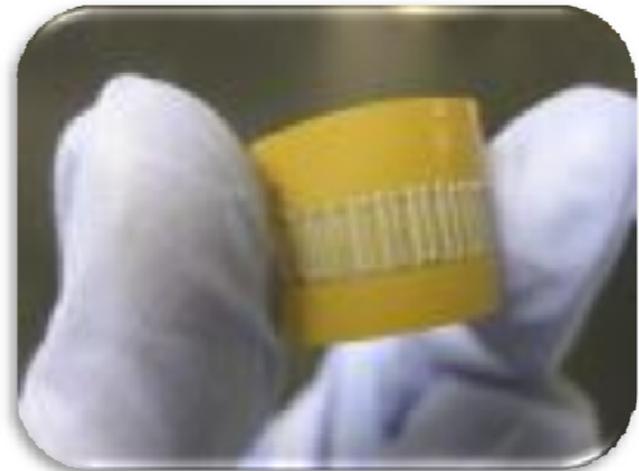
VIBRATIONS



AIR FLOW

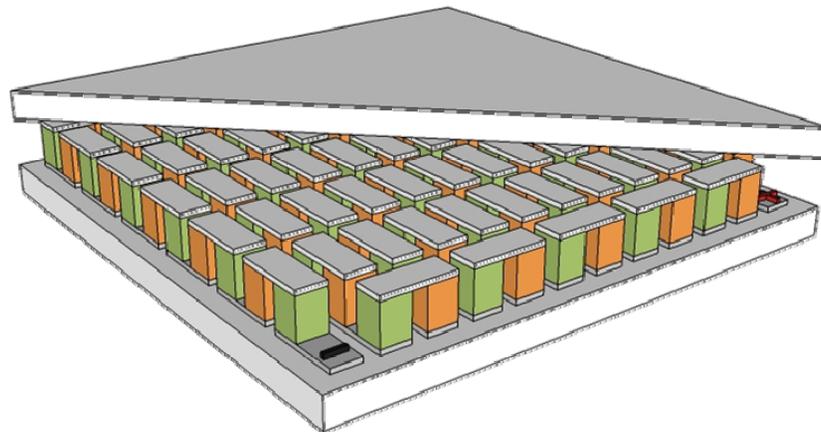
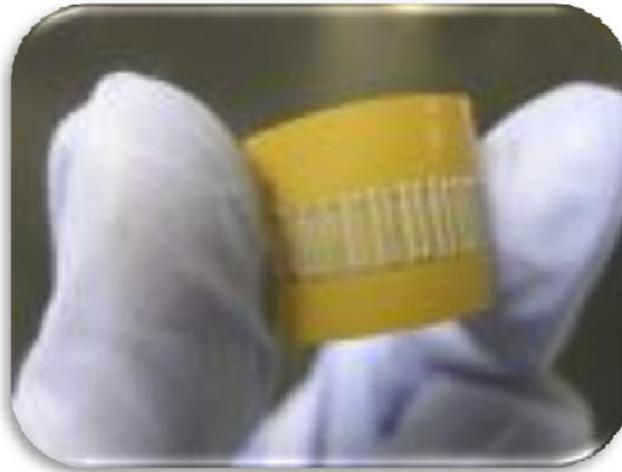


THERMOELECTRIC



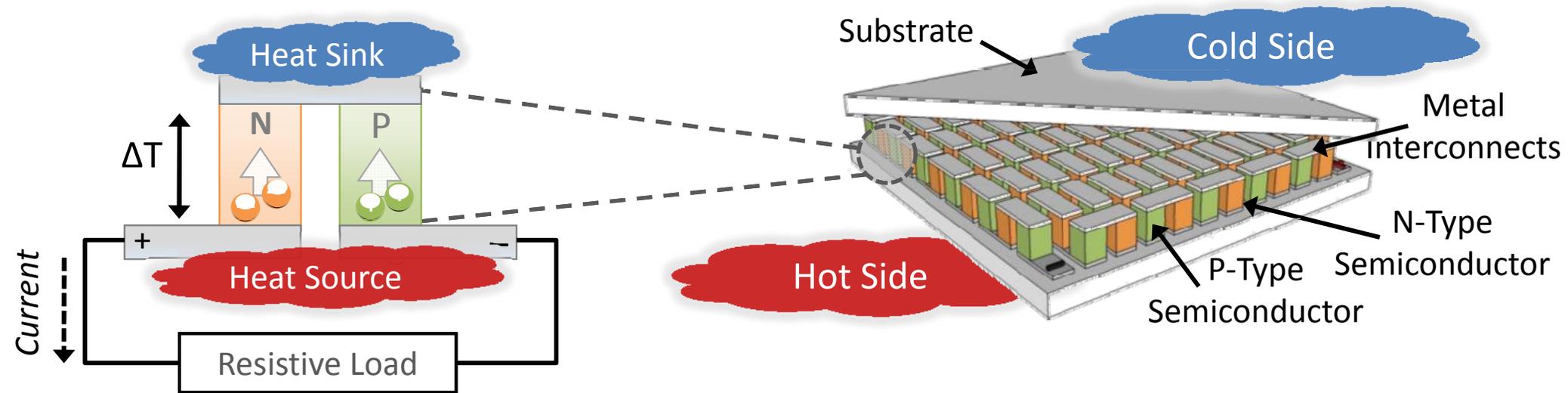
Multi-source energy harvesting

THERMOELECTRIC



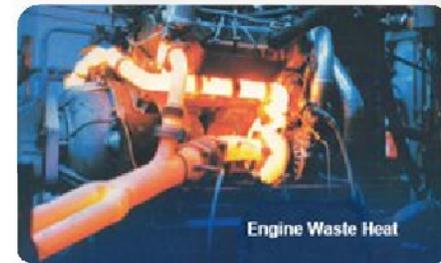
Thermoelectric (TE) Operating Principles

Thermoelectric (TE) Energy Harvesting



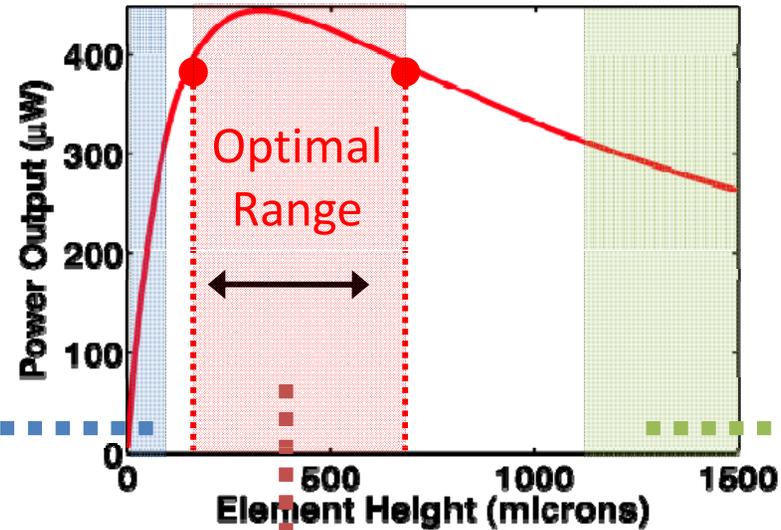
Sources of Waste Heat

Location	Source	Temp. Gradient
Residential	Boilers, Dryers, Freezers, Oven	10-30K
Factories	Exhaust pipes, Boilers, Condensers	10-80K
Vehicles	Engine, Exhaust pipes	60K >100K
Airplanes	Cabin to External	10-50K

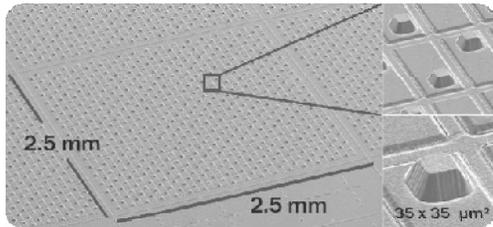


Thermoelectric Design

TE Power Output Optimization



Thin film elements

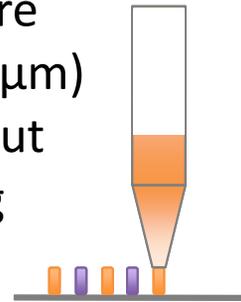


- Microfabrication processes
 - 60 μm max. height
- *Materials intensive*

Micropelt, Inc

Dispenser Printing

- Optimal Feature Sizes (100-500 μm)
- High throughput manufacturing



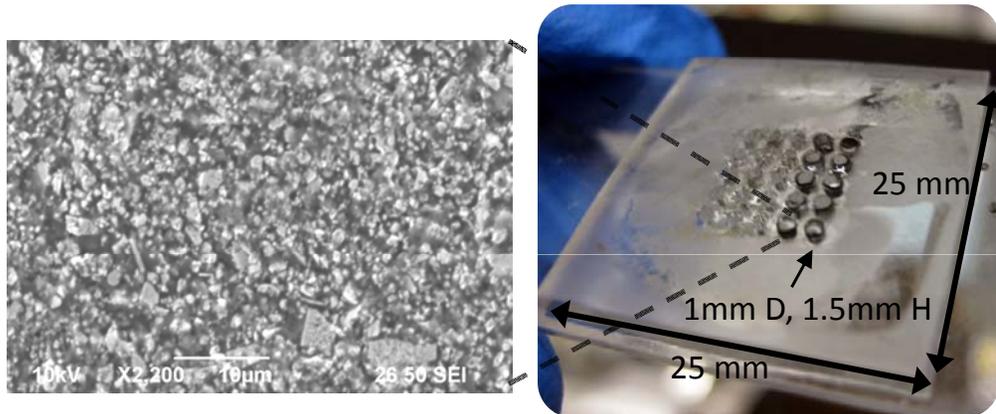
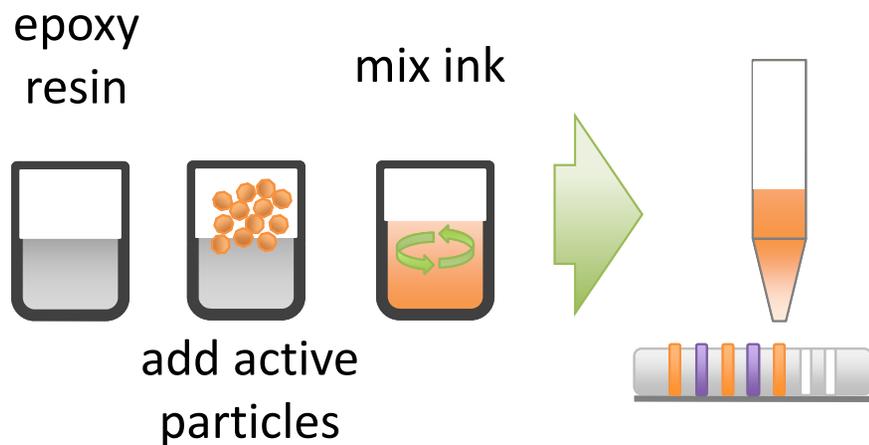
Bulk elements



- Diced elements from ingots
 - 1mm height min.
- *Labor intensive*
 - Manual pick & place

Ferrotec, Inc.

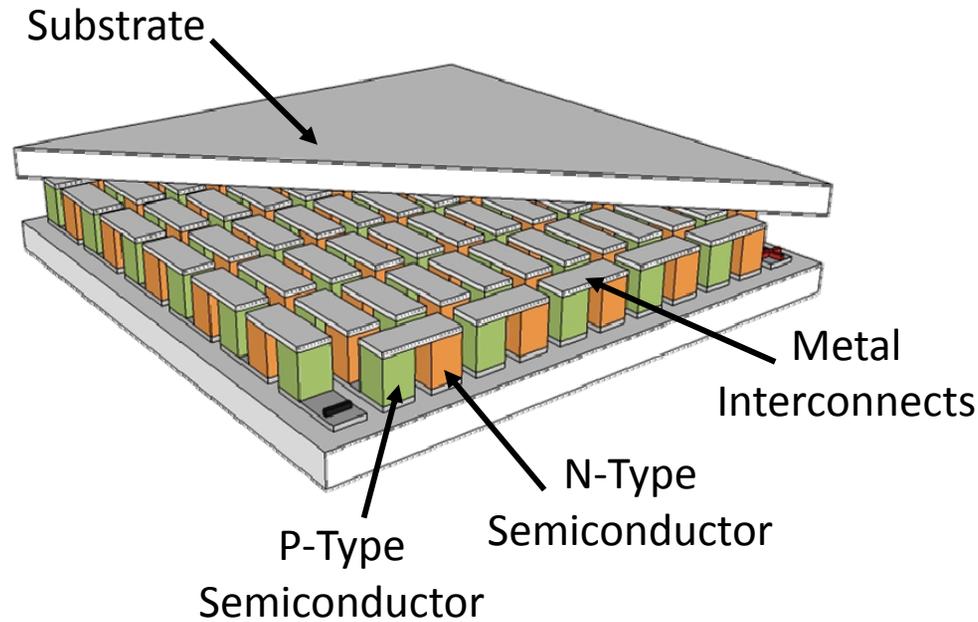
Where we left you 6 months ago:



THERMOELECTRIC

- Meso-scale prototype fabricated using dispenser printing technique
- Printable semiconductor/epoxy thermoelectric materials synthesized

Progress: innovative design of TE harvester

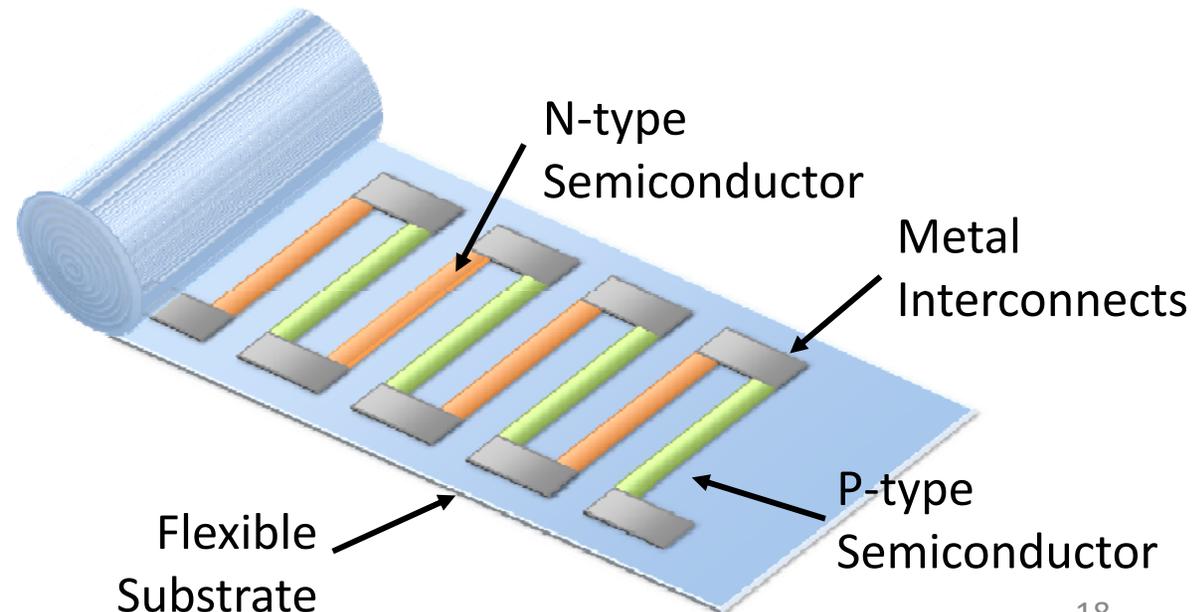


Traditional Design

- Aspect ratios from 1.5 to 2
- Commercially available
- Labor intensive assembly

Planar Design

- High aspect ratio pillars
- High density arrays
 - 900+ couples for $D = 1\text{cm}$
- Takes advantage of printing process



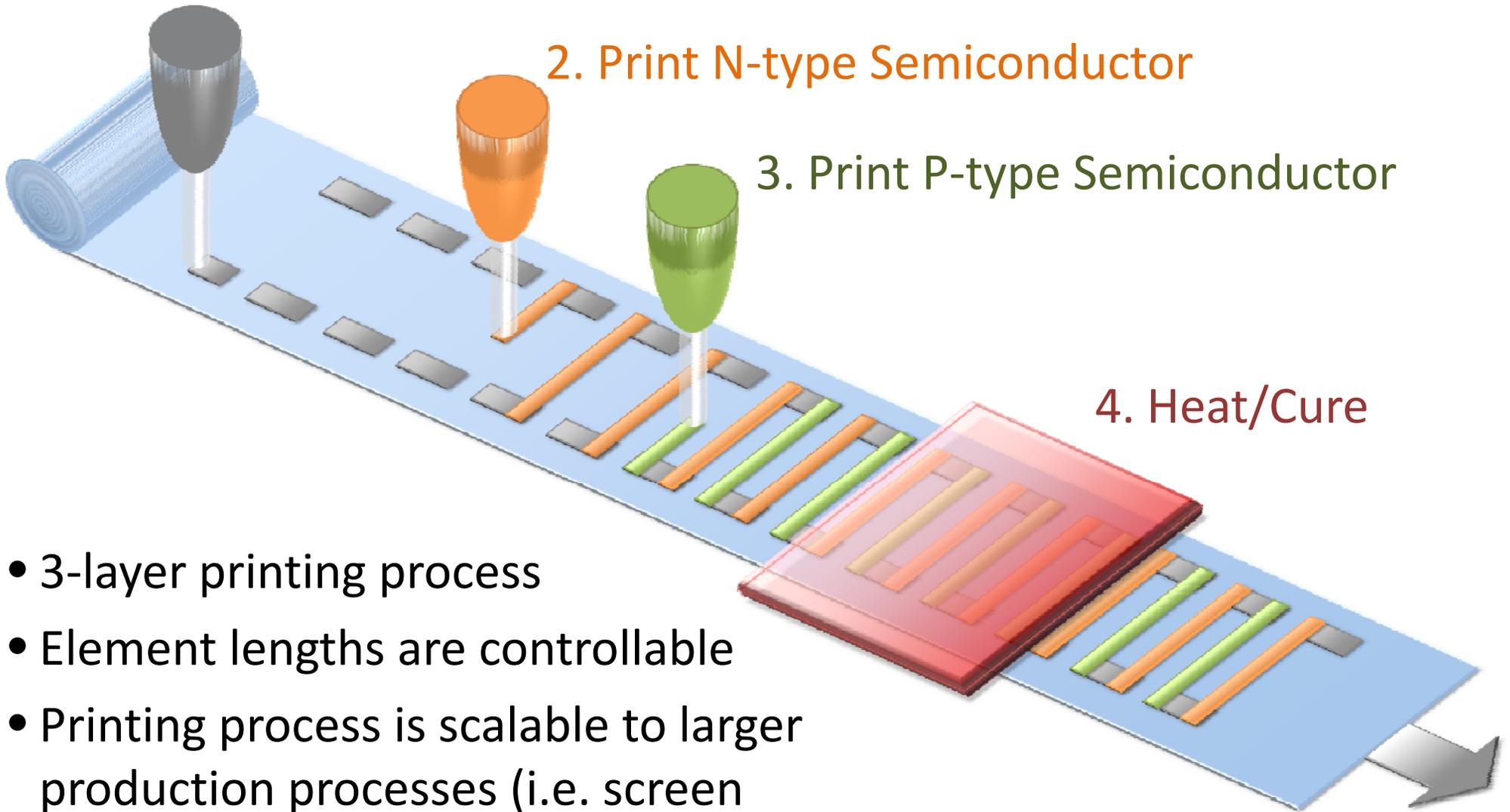
Progress: new design is easily scalable

1. Print Electrodes

2. Print N-type Semiconductor

3. Print P-type Semiconductor

4. Heat/Cure

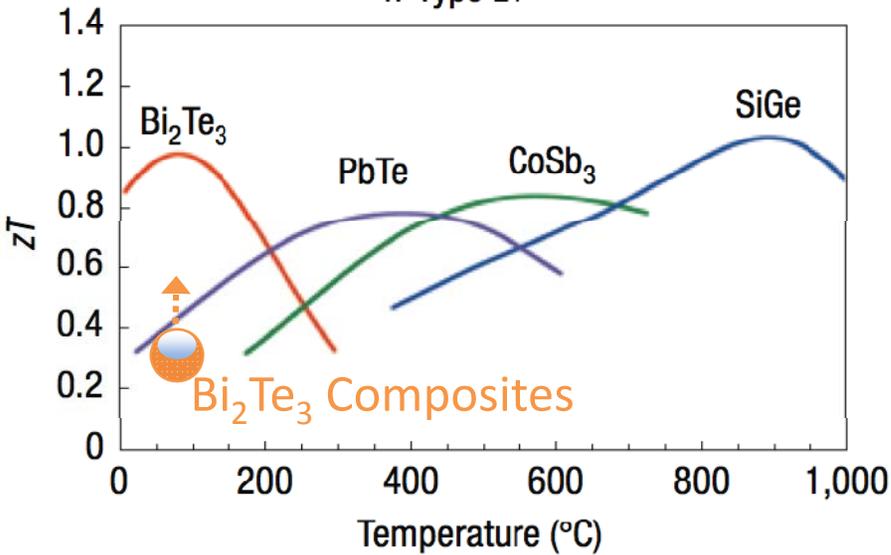


- 3-layer printing process
- Element lengths are controllable
- Printing process is scalable to larger production processes (i.e. screen printing, flexography)

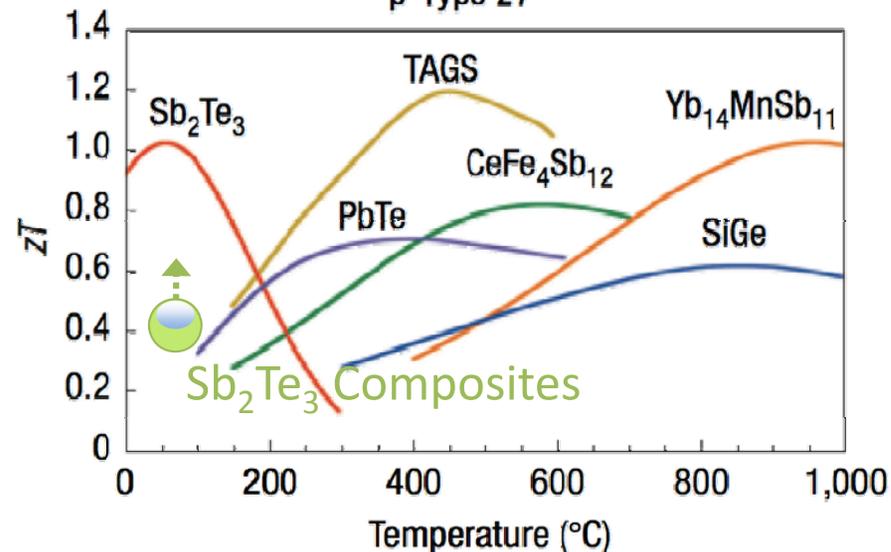
Progress: performance of TE prototype

Thermoelectric Materials

n-Type zT



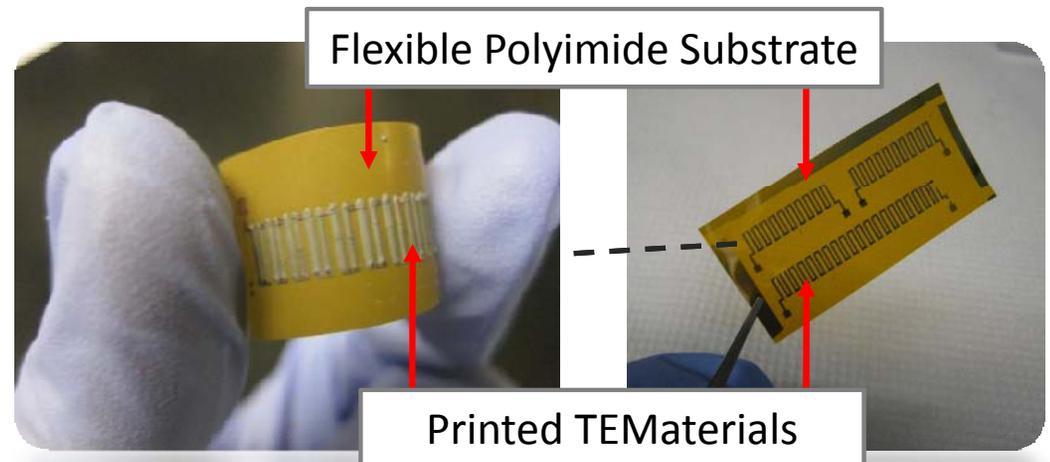
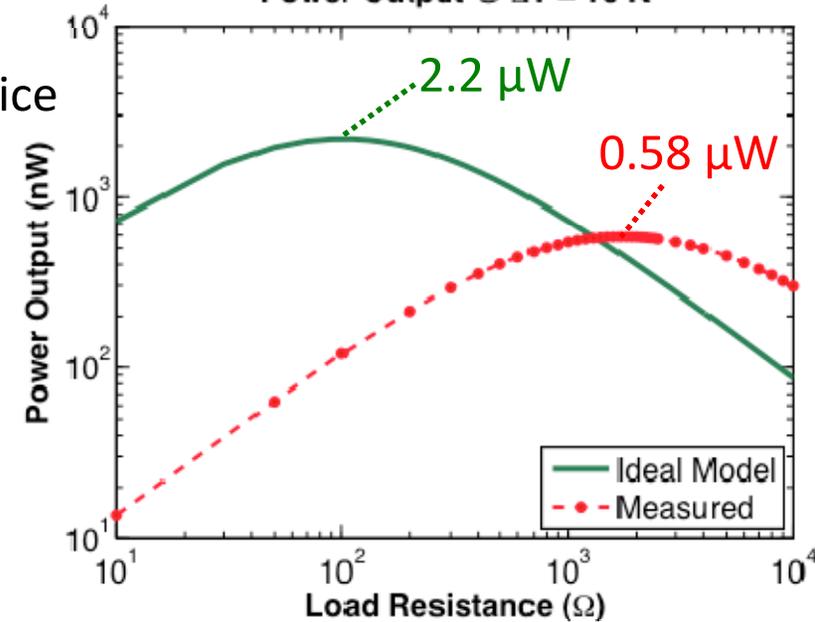
p-Type zT



Flexible TE Devices

- 10 Couple Device
- $\Delta T = 10$ Kelvin
- Losses from contact resistance

Power Output @ $\Delta T = 10$ K



Leg Dim.: 5 mm Length, 500 μ m width, 200 μ m thick

Progress summary

PIEZOELECTRIC

VIBRATIONS

- $P_{\text{rms}} = 1.1 \text{ nW/beam}$,
micro device on ambient source
- Modified frequency by 20 Hz with
printed mass
- Beam signals add when in series

AIR FLOW

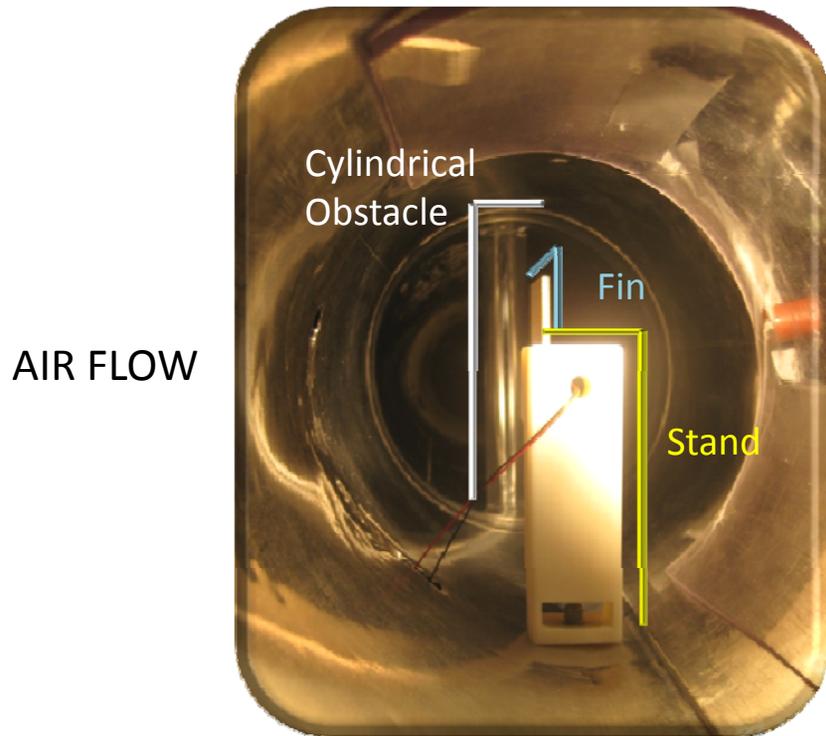
- Meso-scale prototype designed,
built, & characterized in duct
- $P_{\text{rms}} = 1.1 \text{ mW}$, optimal conditions

THERMOELECTRIC

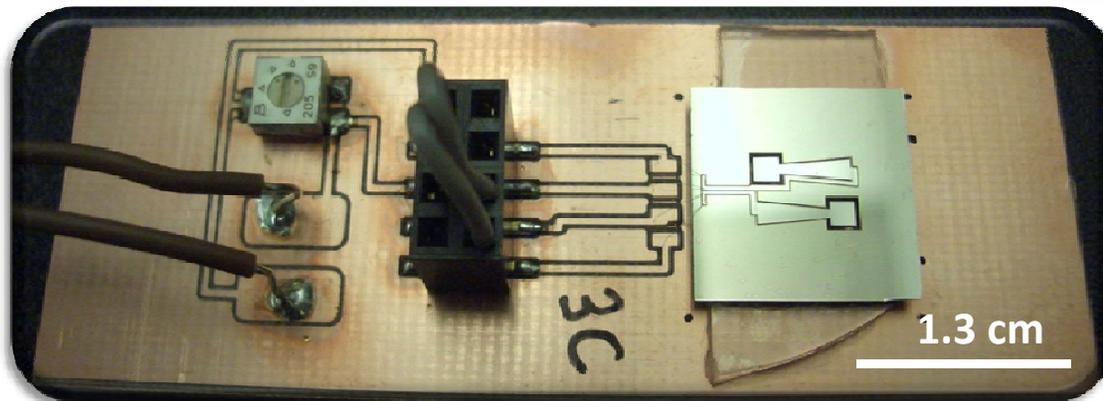
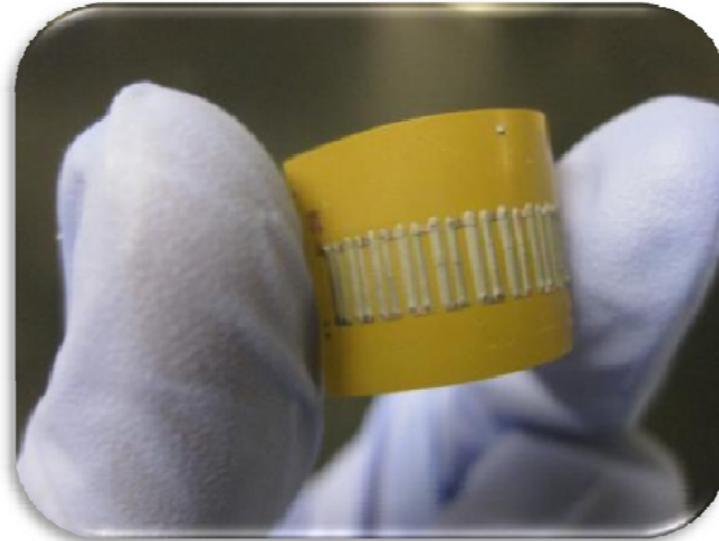
TEMPERATURE DIFFERENCE

- Synthesized efficient, printable
composite TE materials ($ZT \sim 0.4$)
- Developed scalable fabrication
process for meso-scale devices
- $P = 0.58 \text{ } \mu\text{W}$
($\Delta T = 10 \text{ K}$, 10-couple device)

Thank you! Any questions?



THERMOELECTRIC



VIBRATION

Acknowledgements: California Energy Commission, Siemens, CITRIS, Berkeley Manufacturing Institute, Berkeley Wireless Research Center